



PRODUCT OVERVIEW

This EB series of DC-DC converters is an open frame eighth-brick DC-DC converter that conforms to industry standard specifications. These converters operate over the input voltage range of 18 to 36 or 36 to 75 VDC and provide tightly regulated output voltages. The high efficiency of this EB series allows operation over a wide ambient temperature range of -40°C to +123°C with minimal derating. The output is fully isolated from the input and the converter meets Basic Insulation requirements. The standard feature set includes remote On/Off (positive or negative enable), input under-voltage lockout, output overvoltage protection, overcurrent and short circuit protection, output voltage trim, remote sense and over-temperature shutdown with hysteresis.

FEATURES

- DOSA – Standard Form, Fit & Function
- Industry standard 1/8th brick footprint
- 2:1 input voltage range: 18- 36 or 36 – 75Vin
- No minimum load required
- -40 °C to +123 °C operation
- Baseplate Optional 0.500” (12.7mm) tall
- Withstands 100 V input transients
- Fixed-frequency operation
- Full protection (OTP, OCP, OVP, UVLO – auto-restart)
- Remote ON/OFF - positive or negative and Remote sense
- Output voltage trim range: ±10%
- On-board input differential LC filter
- ROHS II Directive 2011/65/EU Compliant
- Meets UL94, V-0 flammability rating
- Compliant to REACH (EC) No 1907/2006
- Designed to meet UL/CSA60950-1, TUV per IEC/EN60950-1, 2nd edition (pending)
- Designed to meet Class B conducted emissions per EN55022

APPLICATIONS:

- Distributed Power Architectures
- Instrumentation
- Data and Wireless Communications
- Servers
- “Bus” Converter Applications

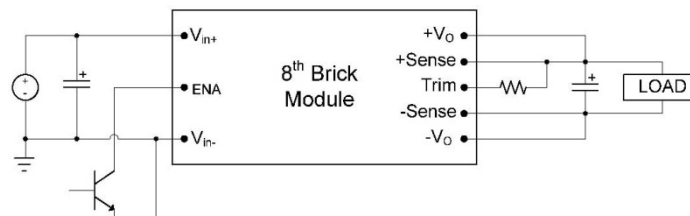
AVAILABLE OPTIONS

- Customizable Input / Output voltages
- SMT or Thru-Hole Mounting
- Higher Power
- Optional Baseplate

Contact DATEL for other series of 8TH - Brick footprint, optimized for Cost Savings or higher performance

MODEL NUMBER	INPUT VOLTAGE	OUTPUT VOLTAGE	OUTPUT CURRENT MAX	EFFICIENCY %	LOAD REGULATION	OPTIONS
EB24S12-14	18 – 36 VDC	12 VDC	14 A	92	± 0.1 %	B, S, N, P
EB24S15-10	18 – 36 VDC	15 VDC	10 A	92	± 0.1 %	B, S, N, P
EB24S24-4	18 – 36 VDC	24 VDC	4 A	92	± 0.1 %	B, S, N, P
EB48S1.2-30	36 – 75 VDC	1.2 VDC	30 A	83	± 0.4 %	B, S, N, P
EB48S3.3-30	36 – 75 VDC	3.3 VDC	30 A	90	± 0.4 %	B, S, N, P
EB48S5-10	36 – 75 VDC	5 VDC	10 A	89	± 0.1 %	B, S, N, P
EB48S5-30	36 – 75 VDC	5 VDC	30 A	91	± 0.1 %	B, S, N, P
EB48S12-14	36 – 75 VDC	12 VDC	14 A	92	± 0.1 %	B, S, N, P
EB48S12-8	36 – 75 VDC	12 VDC	8 A	92	± 0.1 %	B, S, N, P
EB48S15-10	36 – 75 VDC	15 VDC	10 A	92	± 0.1 %	B, S, N, P
EB48S24-5	36 – 75 VDC	24 VDC	4 A	93	± 0.1 %	B, S, N, P
EB48S50-1.2	36 – 75 VDC	50 VDC	1.2 A	89	± 0.1 %	B, S, N, P

CONNECTION DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Parameters	Conditions	Model	Min.	Typical	Max.	Units
Input Voltage						
Continuous	DC	24V _{in}	0		36	Volts
		48V _{in}	0		75	
Operating Ambient Temperature	With Derating	All	-40		+123	°C
Storage Temperature		All	-55		+125	°C

Stresses above the absolute maximum ratings can cause permanent damage to the device.

ELECTRICAL SPECIFICATIONS

Note: All specifications are typical at nominal input, full load at 25°C, Airflow=300 LFM, V_{in} = Nominal, C_{in}=33 μF, unless otherwise noted

INPUT CHARACTERISTICS

Parameters	Conditions	Model	Min.	Typical	Max.	Units
Operating Input Voltage		24V _{in}	9	24	36	Volts
		48V _{in}	36	48	75	
Input Under Voltage Lockout						
Turn-On Voltage Threshold		24V _{in}	17.2	17.6	18	Volts
		48V _{in}	34.2	35	35.9	
Turn-Off Voltage Threshold		24V _{in}	15.8	16.2	16.6	Volts
		48V _{in}	32.4	33.2	34.1	
Input Voltage Transient	100 ms	24V _{in}		100		Volts
Maximum Input Current	100% Load, V _{in} =9V	24V _{in}			9300	mA
	100% Load, V _{in} =18V	48V _{in}			5300	
No-Load Input Current	V _{in} =Nominal input	EB24S12-14		250		mA
		EB24S15-10		180		
		EB24S24-4		200		
		EB48S1.2-30		45		
		EB48S3.3-30		50		
		EB48S5-10		50		
		EB48S5-30		100		
		EB48S12-14		100		
		EB48S12-8		100		
		EB48S15-10		60		
EB48S24-5		60				
EB48S50-1.2		60				
Off Converter Input Current	Shutdown input idle current	All		2	5	mA
Inrush Current (I _{2t})	As per ETS300 132-2	All			0.01	A ² s
Input Reflected-Ripple Current	5Hz to 50MHz	All		10	20	mAPK-PK

OUTPUT CHARACTERISTIC

Parameters	Conditions	Model	Min.	Typical	Max.	Units
Output Voltage Set Point	V_{in} =Nominal V_{in} , $I_o = I_{o_max}$, $T_c=25^{\circ}C$	$V_o=3.3$	3.2505	3.3	3.3495	Volts
		$V_o=5.0$	4.925	5	5.075	
		$V_o=12$	11.82	12	12.18	
		$V_o=15$	14.775	15	15.225	
		$V_o=24$	23.64	24	24.36	
		$V_o=50$	49.25	50	50.75	
Output Voltage Regulation						
Line Regulation	V_{in} =High line to Low line Full Load	All			± 0.1	%
Load Regulation	I_o = Full Load to min. Load	All			± 0.1	%
Temperature Coefficient	$T_c=-40^{\circ}C$ to $+85^{\circ}C$				± 0.03	%/ $^{\circ}C$
Output Voltage Ripple and Noise						
Peak-to-Peak	Full Load, 20MHz bandwidth 10uF tantalum and 1uF ceramic capacitor	$V_o=1.2V$			75	mV
		$V_o=3.3V$				
		$V_o=5V$				
		$V_o=12V$			100	
		$V_o=15V$			150	
		$V_o=24V$			200	
Operating Output Current Range		$S1.2-30$	0		30000	mA
		$S3.3-30$	0		30000	
		$S5-10$	0		10000	
		$S5-20$	0		20000	
		$S12-14$	0		14000	
		$S12-8$	0		8000	
		$S15-10$	0		10000	
		$S24-5$	0		5000	
$S50-1.2$	0		1200			
Output DC Current-Limit Inception	Output Voltage= $90\% V_{o_nominal}$		110	140	170	%
Maximum Output Capacitance	Full load, Resistance	$V_o=1.2V$			20000	μF
		$V_o=3.3V$			20000	
		$V_o=5V$			4700	
		$V_o=12V$			4700	
		$V_o=15V$			2200	
		$V_o=24V$			1000	
		$V_o=50V$			220	

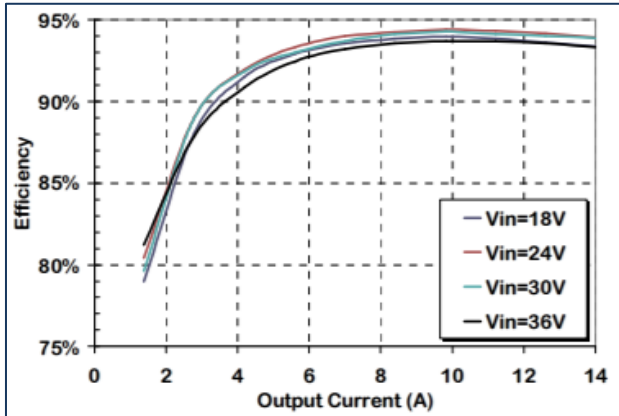
FEATURE CHARACTERISTICS

Parameter	Conditions	Model	Min	Typ	Max	Unit
Switching Frequency		EB24S12-14		410		kHz
		EB24S15-10		410		
		EB24S24-4		325		
		EB48S1.2-30		350		
		EB48S3.3-30		TBD		
		EB48S5-10		410		
		EB48S5-30		TBD		
		EB48S12-14		410		
		EB48S12-8		410		
		EB48S15-10		410		
		EB48S24-5		410		
EB48S50-1.2		350				
Output Voltage Trim Range ¹		All	-20		+10	%
Remote Sense Compensation ¹		All			+10	%
Output Over-voltage Protection	Non-latching	All	115	120	140	%
Over-temperature Protection	Average PCB temp, non-latching	All		135		°C
Peak Backdrive Output Current during startup into pre-biased output	C _{OUT} =220µF, aluminum Sinking current from external voltage source equal to V _{OUT} – 0.6V and connected to the output via 1Ω resistor.	All		400	500	mA
Backdrive Output Current in OFF state	Converter disabled			0	5	mA
Enable to Output Turn-ON Time	V _{OUT} = 0.9*V _{OUT_NOM}			20		ms
Output Enable ON/OFF	All voltages are WRT – Vin. Converter has internal pull-up of approx. 5V					
Negative Enable			-0.5		0.8	VDC
Converter ON			2.4		20	VDC
Converter OFF						
OFF Positive Enable			2.4		20	VDC
Converter ON			-0.5		0.8	VDC
Converter OFF				0.25	1	mA
Output Voltage Overshoot @ startup				0	2	%V _o
Auto-Restart Period	With all protection features			100		ms
Efficiency Full Load		EB24S12-14		92.5		%
		EB24S15-10		92		
		EB24S24-4		92		
		EB48S1.2-30		83		
		EB48S3.3-30		90		
		EB48S5-10		89		
		EB48S5-30		92		
		EB48S12-14		93		
		EB48S12-8		92		
		EB48S15-10		92		
		EB48S24-5		93		
EB48S50-1.2		89				

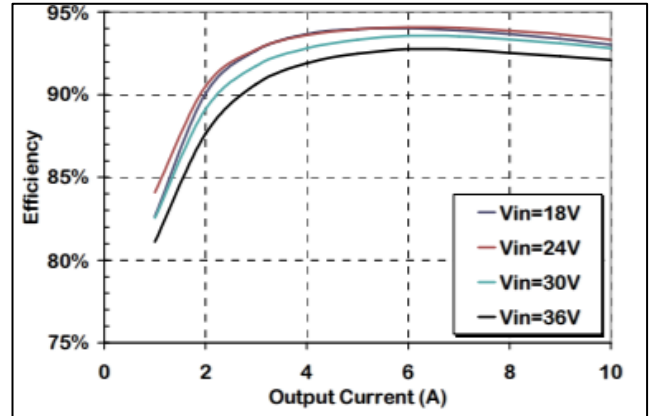
Parameter	Conditions	Models	Min	Tvo.	Max	Unit
Load Change 50%-75% or 25% to 50% of I _{out} Max, di/dt = 0.1 A/μs	Co = 1 μF ceramic and 10 μF tantalum	All		100	300	mV
Settling Time to 1% of V _{out}		All		50		μs
Load Change 50%-75% or 25% to 50% of I _{out} Max, di/dt = 1.0 A/μs	Co = 1 μF ceramic and 330 μF Tantalum	All		100	200	mV
Settling Time to 1% of V _{out}		All		100		μs
Isolation Capacitance				1000		pF
Isolation Resistance			10			MΩ
Isolation Voltage – Input to Output			2250			V
Isolation Voltage – Input to Baseplate			1500			V
Isolation Voltage –Output to baseplate			1000			V
RELIABILITY						
Per Telcordia SR-332, Issue 2: Method I, Case 3 (I _Q =80% of I _{Q_max} , T _A =40°C, airflow = 200 lfm, 90% confidence)	MTFB	EB24S12-14 EB24S15-10 EB24S24-4 EB48S1.2-30 EB48S3.3-30 EB48S5-10 EB48S5-30 EB48S12-14 EB48S12-8 EB48S15-10 EB48S24-5 EB45S50-1.2		2,216,014 2,213,640 3,233,780 3,774,635 TBD 3,823,983 TBD 2,281,055 TBD 2,404,569 2,248,774 2,970,210		Hours
	FITs (failures in 10 ⁹ hours)	EB24S12-14 EB24S15-10 EB24S24-4 EB48S1.2-30 EB48S3.3-30 EB48S5-10 EB48S5-30 EB48S12-14 EB48S12-8 EB48S15-10 EB48S24-5 EB45S50-1.2		451 452 309 265 TBD 262 TBD 438 TBD 416 445 337		/10 ⁹ Hours

Notes: Combination of trim + remote sense cannot exceed 10% of V_{O_nom}

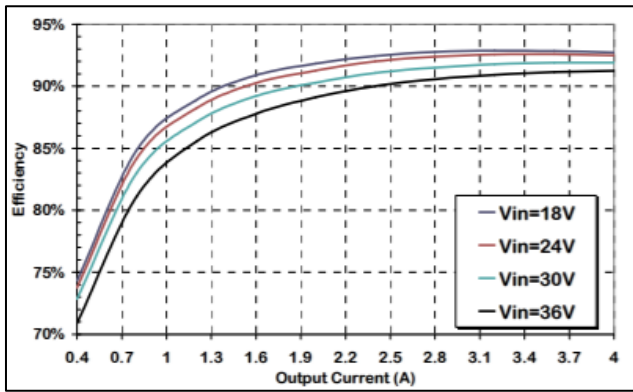
Efficiency vs. Load Curves



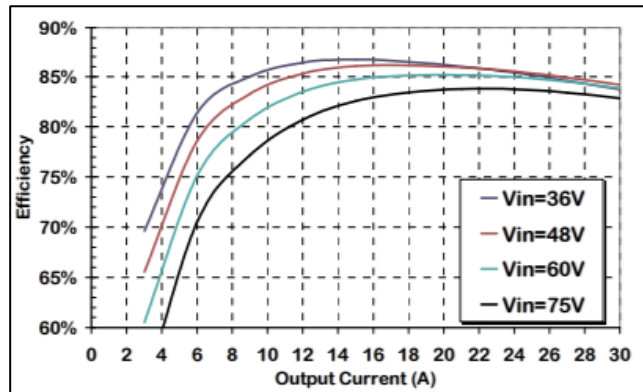
EB24S12-14



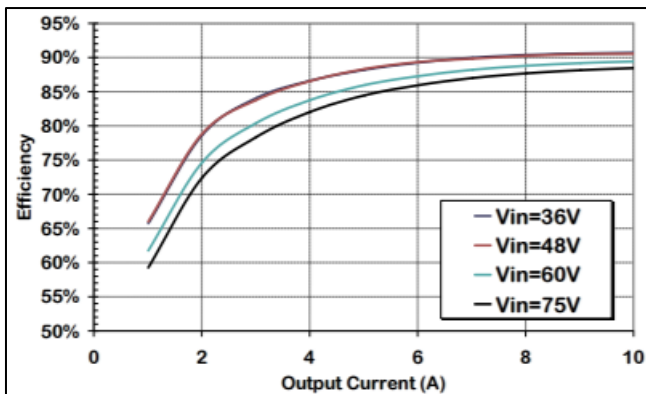
EB24S15-10



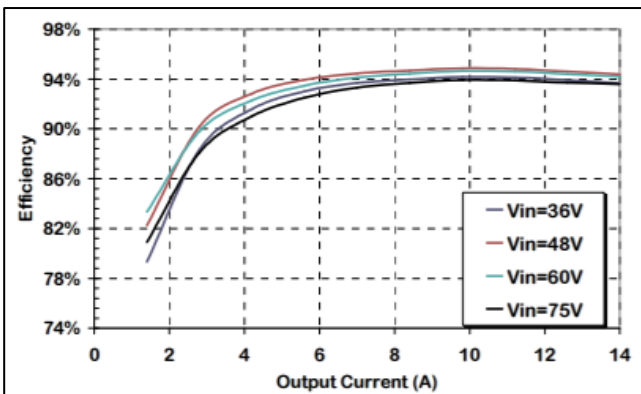
EB24S24-4



EB48S1.2-30

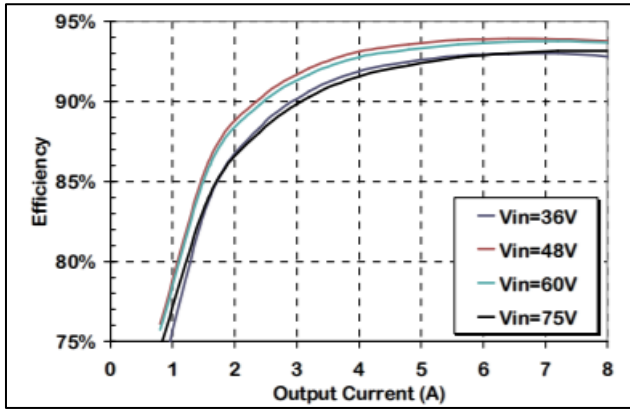


EB48S5-10

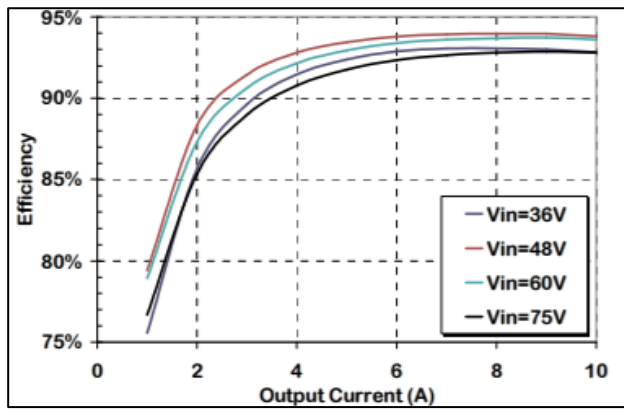


EB48S12-14

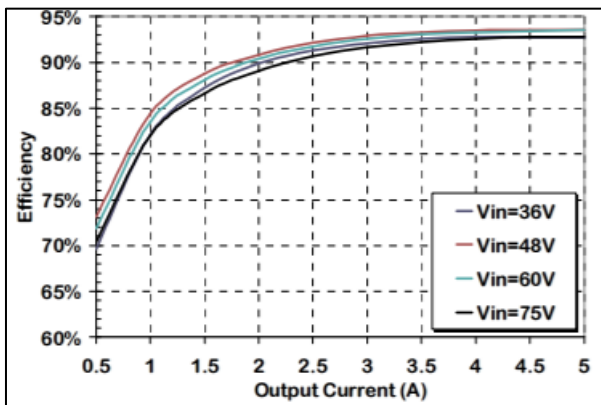
Efficiency vs. Load Curves



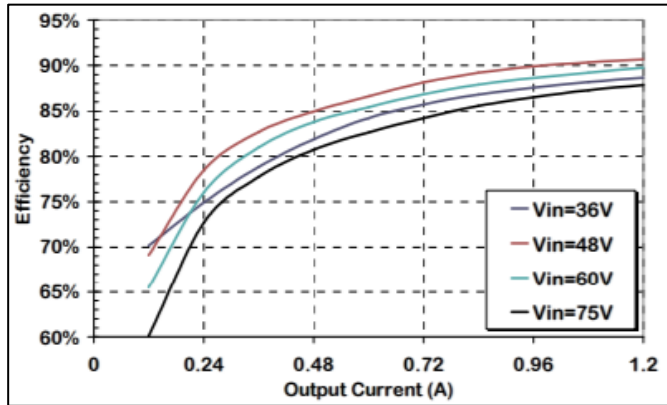
EB48S12-8



EB48S15-10

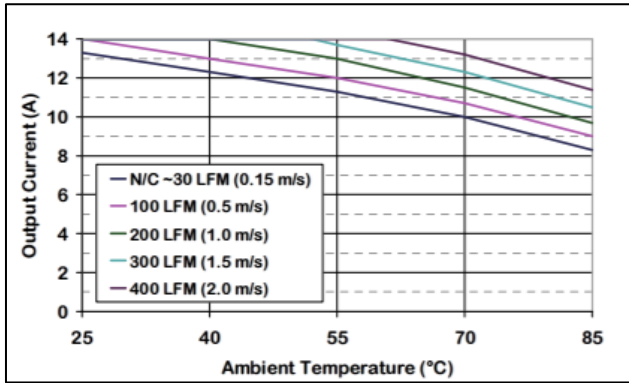


EB48S24-5

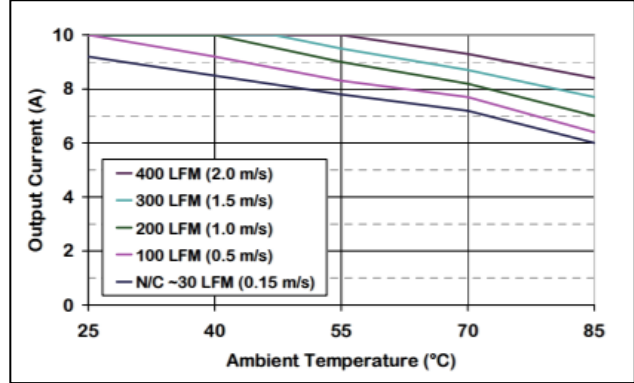


EB48S50-1.2

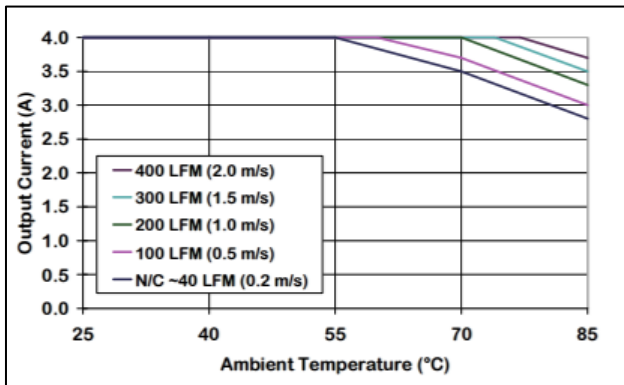
Output Current Derating vs Ambient Temperature & Airflow



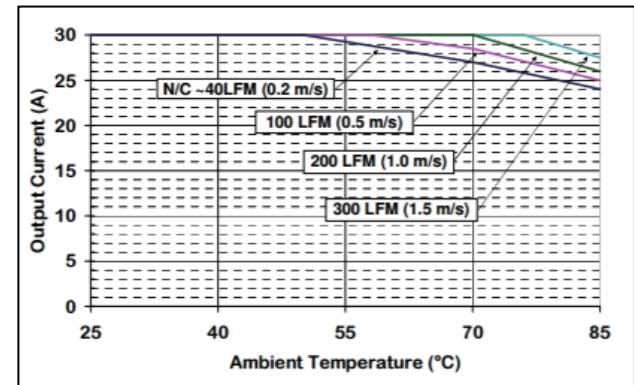
EB24S12-14 at Vin = 24 V (without baseplate) airflow from Pin 1 to pin 3



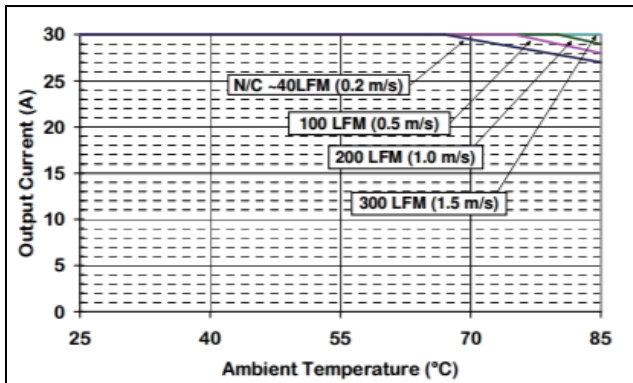
EB24S15-10 at Vin = 24 V (No baseplate) airflow from Pin 1 to pin 3



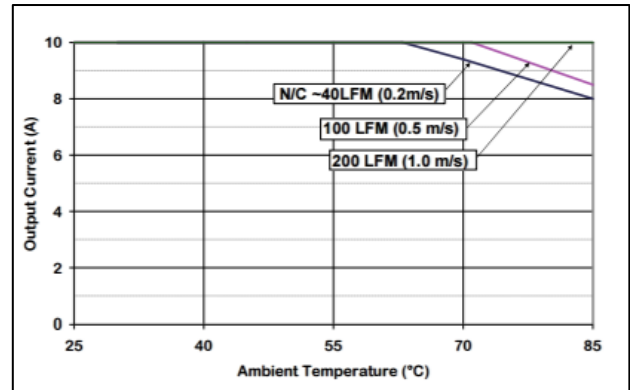
EB24S24-4 at Vin = 24 V (without baseplate) airflow from pin 1 to pin 3



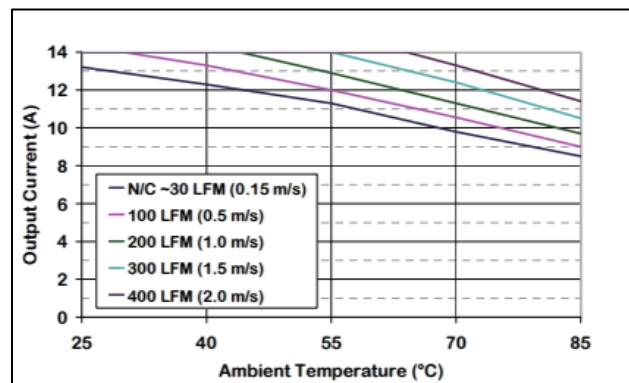
EB48S1.2-30 at Vin = 24 V (No baseplate) airflow from pin 1 to pin 3



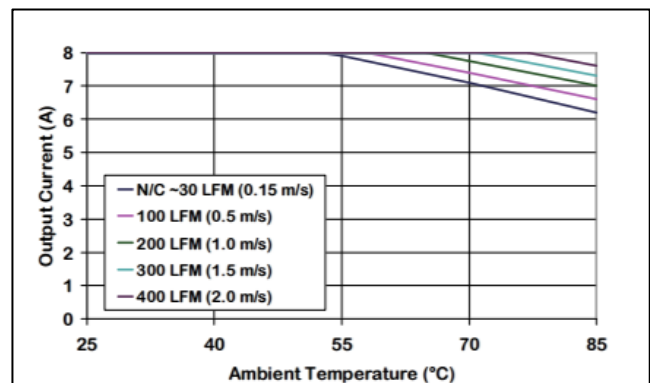
EB48S1.2-30 at Vin = 48 V (with baseplate) airflow from pin 1 to pin 3



EB48S5-10 at Vin = 48 V (No baseplate) airflow from pin 1 to pin 3

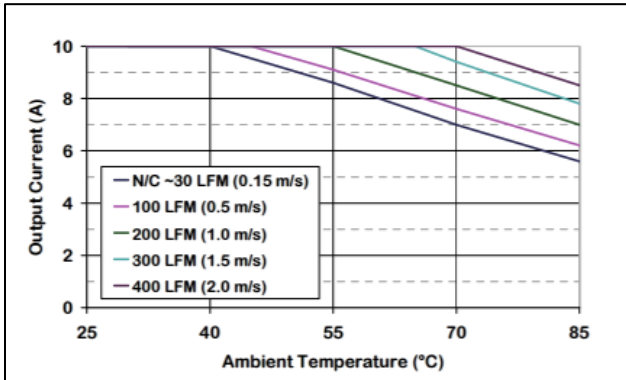


EB48S12-14 at Vin = 48 V (without baseplate) airflow from pin 1 to pin 3

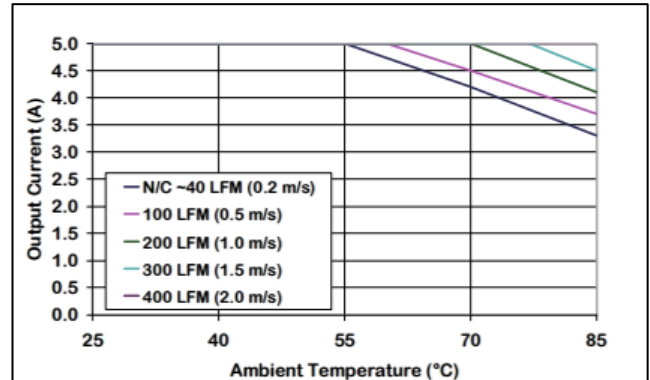


EB48S12-8 at Vin = 48 V (No baseplate) airflow from pin 1 to pin 3

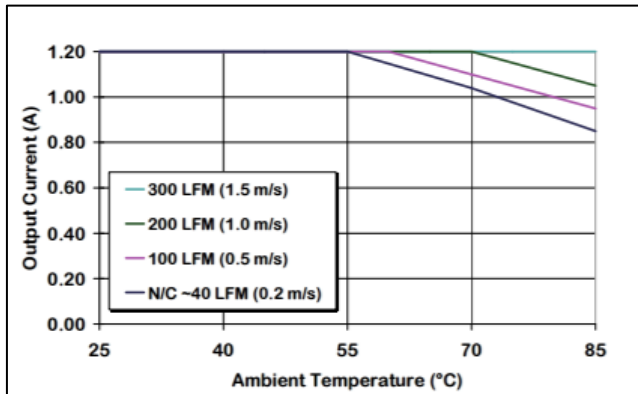
Output Current Derating vs Ambient Temperature & Airflow



EB48S15-10 at Vin = 48 V (without baseplate) airflow from pin 1 to pin 3

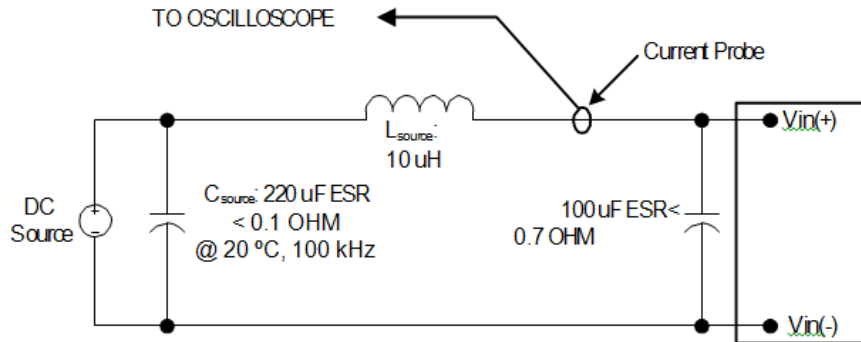


EB48S24-5 at Vin = 48 V (No baseplate) airflow from pin 1 to pin 3



EB48S50-1.2 at Vin = 48 V (without baseplate) airflow from pin 1 to pin 3

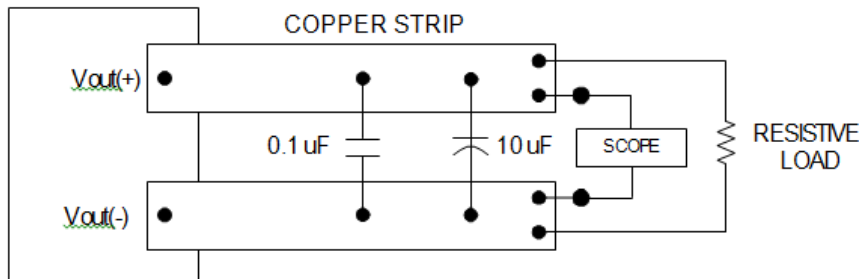
INPUT REFLECTED RIPPLE TEST SETUP:



Note: Measure input reflected-ripple current with a simulated source inductance (L_{test}) of 10 uH. Capacitor CS offsets possible source impedance.

Input Reflected-ripple Current Test Setup.

OUTPUT RIPPLE TEST SETUP:



Note: Use a 0.1 μF X7R ceramic capacitor and a 10 μF @ 25V tantalum capacitor. Scope measurement should be made using a BNC socket. Position the load 3 in. [76mm] from module.

Peak-to-Peak Output Noise Measurement Test Setup.

OUTPUT VOLTAGE TRIM

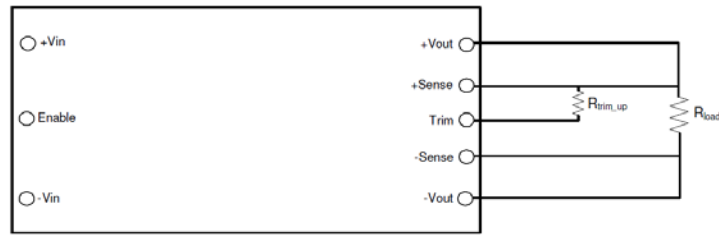
Output voltage adjustment is accomplished by connecting an external resistor between the Trim Pin and either the +Sense or –Sense pins.

▪ **TRIM UP EQUATION:**

Where R_{trim_up} is the resistance value in k-ohms and Δ% is the percent change in the output voltage. E.g. to trim the output up 10%,

$$R_{\text{trim_up}} = \left[\frac{5.1 \times V_{o_nom} \times (100 + \Delta\%)}{1.225 \times \Delta\%} - \frac{510}{\Delta\%} - 10.2 \right] \times \text{k}\Omega$$

or R_{trim_up} = 168 kOhm.

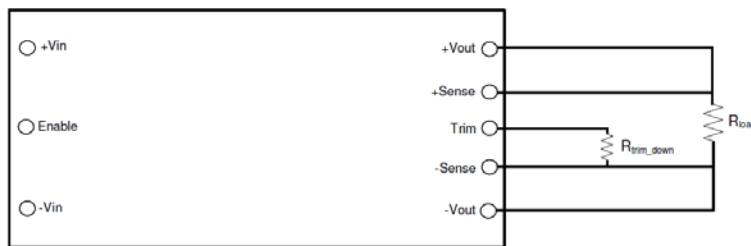


Trim UP circuit configuration

▪ **TRIM DOWN EQUATION:**

$$R_{\text{trim_down}} = \left(\frac{510}{\Delta\%} - 10.2 \right) \times \text{k}\Omega$$

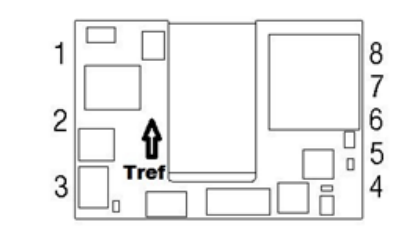
Where **Rtrim_down** is the resistance value in k ohms and $\Delta\%$ is the percent change in the output voltage.



Trim DOWN circuit configuration

THERMAL DERATING

- It is preferable that the DC-DC module has an unobstructed flow of air across the unit for best thermal performance. Components taller than ~ 2mm in front of the module can deflect airflow and possibly create hotspots.
- Significant cooling is achieved through conductive flow from the modules I/O pins to the host PCB. Sufficiently large traces connecting the dc-dc converter to the source and load will help ensure thermal derating performance will meet or exceed the derating curves published in this datasheet. Thermal reliefs are not recommended on power pin connections.
- If the module is expected to be operated near the load limits defined in the derating curves, in-system verification of module derating performance should be performed to ensure long-term system reliability. Peak temperatures are to be measured using infrared thermography or by gluing a fine gauge (AWG #40) thermocouple at the TREF location(s) shown below. Temperature at the specified location is not to exceed 123°C in order to maintain converter reliability.



INPUT UNDERVOLTAGE LOCKOUT

- The converter is disabled until the input voltage has exceeded the UVLO turn-on threshold. Once the input voltage exceeds this level (see Input Under-Voltage Lock-out in Electrical Specifications table) the module will commence soft-start. Hysteresis of 2-3 volts minimizes the likelihood of pulling the input voltage below the turn-off threshold during startup which could create an undesirable on/off cycling condition. Once started, the converter will continue to operate until the input voltage subsequently falls below the UVLO turn-off threshold.

ENABLE PIN FUNCTION

- The module has a remote enable function that allows it to be turned on or off remotely. The Enable pin is referenced to the negative input pin (-Vin) of the converter. Modules can be ordered with either negative or positive enable.

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- With the negative enable option, the converter will not turn on unless the enable pin is connected to $-V_{in}$. The positive enable option allows the converter to turn on as soon as voltage sufficient to exceed the UVLO threshold of the converter has been applied to the input terminals. In this case the module is turned off by connecting the Enable pin to $-V_{in}$. On/off thresholds are shown in the Electrical Specifications table.

OUTPUT OVERVOLTAGE PROTECTION

- The module has an independent feedback loop that will disable the output of the converter if a voltage greater than about 125% of the nominal set point is detected. When this threshold is reached, the converter will shut down and remain off for the amount of time specified by the Auto-Restart Period. The converter will attempt a restart once this period of time has elapsed.

OUTPUT OVER-TEMPERATURE PROTECTION

- To provide protection under certain fault conditions, the unit is equipped with a thermal shutdown circuit. The unit will shut-down if the average PCB temperature exceeds approx. 135°C. Keep in mind that thermal shutdown is not intended as a guarantee that the unit will survive temperatures beyond its rating. The module will automatically restart once it has cooled below the shutdown temperature minus hysteresis (typically 20°C.)

SMT VERSION LAYOUT CONSIDERATIONS (IF APPLICABLE)

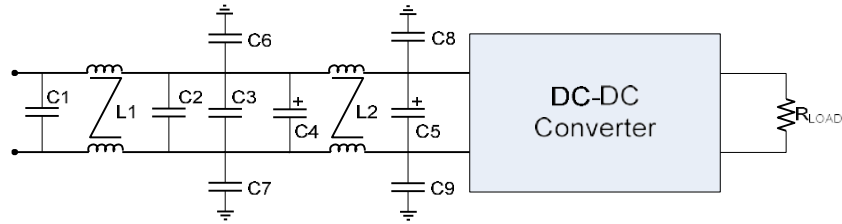
- Copper traces with sufficient cross-section must be provided for all output & input pins. SMT pads tied to internal power/ground planes must have multiple vias around each SMT pad to couple expected current loads from module pins into internal traces/planes. One 0.024" (0.6mm) diameter via for each 4A of expected source or load current must be provided as close to the termination as possible, preferably in the direction of current flow from SMT pad to load. Vias must be at least 0.024" (0.6 mm) away from the SMT pad to prevent solder from flowing into the vias.
- SMT pads on the host card are to be 0.110" (2.79mm) diameter. Solder paste screen opening should be 0.105" diameter and the screen should be 0.006" (0.15 mm) thick (other thicknesses are possible; 0.006" provides a good compromise between solder volume and coplanarity compensation.)

PARALLELING CONVERTERS

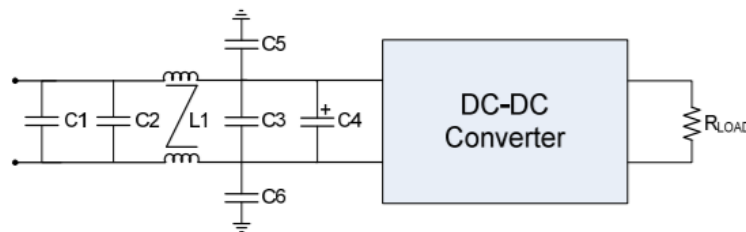
- Modules may be paralleled but it is recommended that the total power draw not exceed the output power rating of a single module. External sharing controllers are recommended for reliability and to ensure equal distribution of the load to the converters. In lower current applications, ORing diodes can be used to prevent converter interactions and improve current sharing.

EMC COMPLIANCE:

To meet Class B compliance for EN55022 (CISPR 22) or FCC part 15 sub part j, the following input filter is required:



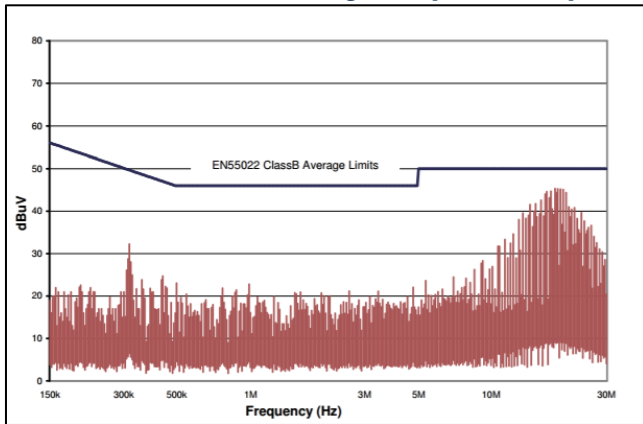
EMI Filter for EB24S24-4, EB48S1.2-30, EB48S12-14 & EB48S50-1.2



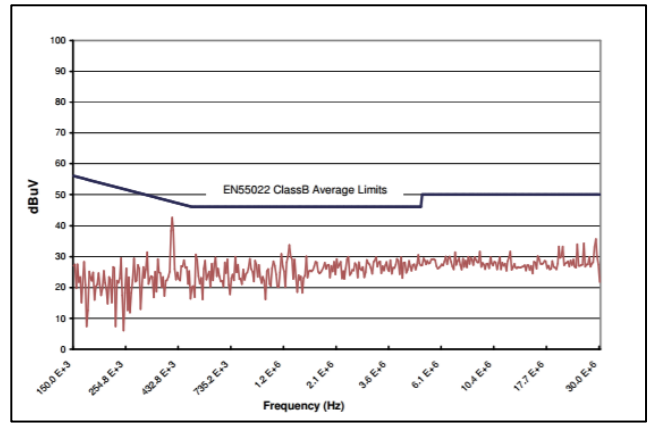
EMI Filter for EB48S5-10, EB48S12-8 & EB48S24-5

Model No.	C1, C2, C3	C4	C5	C6	C7, C8, C9	L1	L2
EB24S12-14	TBD	TBD	TBD	TBD	TBD	TBD	TBD
EB24S15-10	TBD	TBD	TBD	TBD	TBD	TBD	TBD
EB24S24-4	2.2μF Ceramic	Not Used	100μF Electrolytic	8.2 nF	8.2 nF	0.59mH	0.59mH
EB48S1.2-30	2.2μF Ceramic	Not Used	100μF Electrolytic	8.2 nF	8.2 nF	0.77mH	0.77mH
EB48S3.3-30	TBD	TBD	TBD	TBD	TBD	TBD	TBD
EB48S5-10	2.2μF Ceramic	220μF Electrolytic	10 nF	10 nF	Not Used	1.32mH	Not Used
EB48S5-30	TBD	TBD	TBD	TBD	TBD	TBD	TBD
EB48S12-14	2.2μF Ceramic	Not Used	100μF Electrolytic	8.2 nF	8.2 nF	0.77mH	0.77mH
EB48S12-8	2.2μF Ceramic	100μF Electrolytic	10 nF	10 nF	Not Used	1.32mH	Not Used
EB48S15-10	TBD	TBD	TBD	TBD	TBD	TBD	TBD
EB48S24-5	2.2μF Ceramic	100μF Electrolytic	10 nF	10 nF	Not Used	1.32mH	Not Used
EB48S50-1.2	2.2μF Ceramic	Not Used	100μF Electrolytic	8.2 nF	8.2 nF	0.59mH	0.59mH

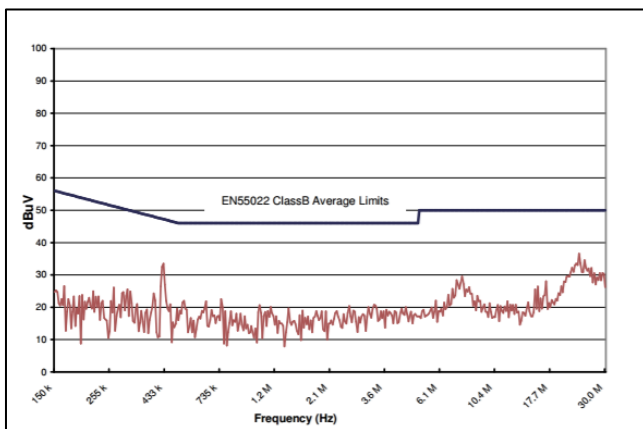
Conducted Emissions using the specified input filter



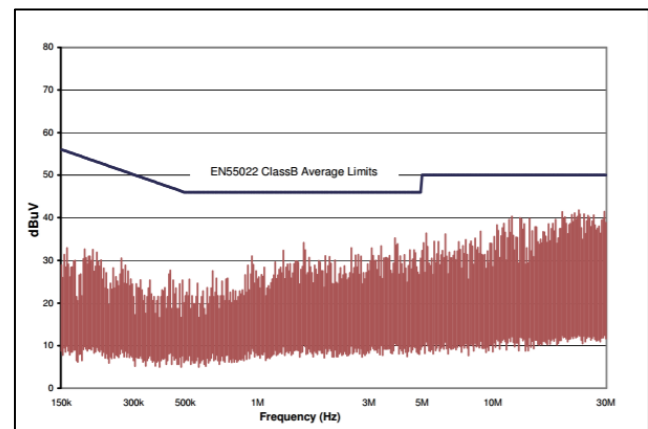
EB24S24-4 @ Vin =24 Volts



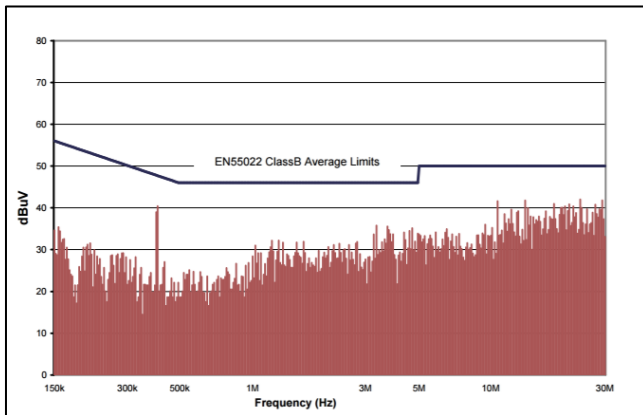
EB48S1.2-30 @ Vin=48 Volts



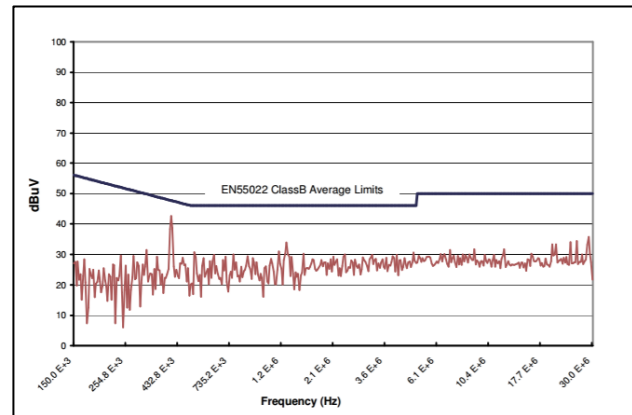
EB48S12-14 @ Vin =24 Volts



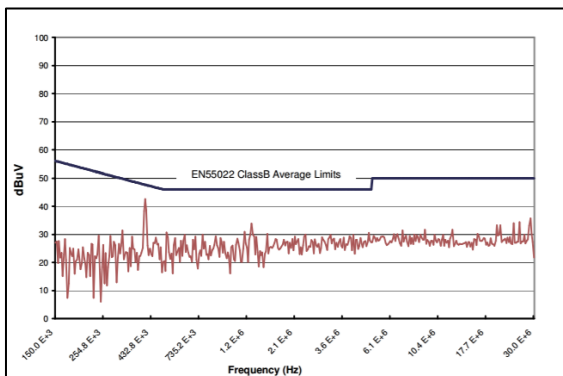
EB48S50-1.2 @ Vin=48 Volts



EB48S5-10 @ Vin =24 Volts

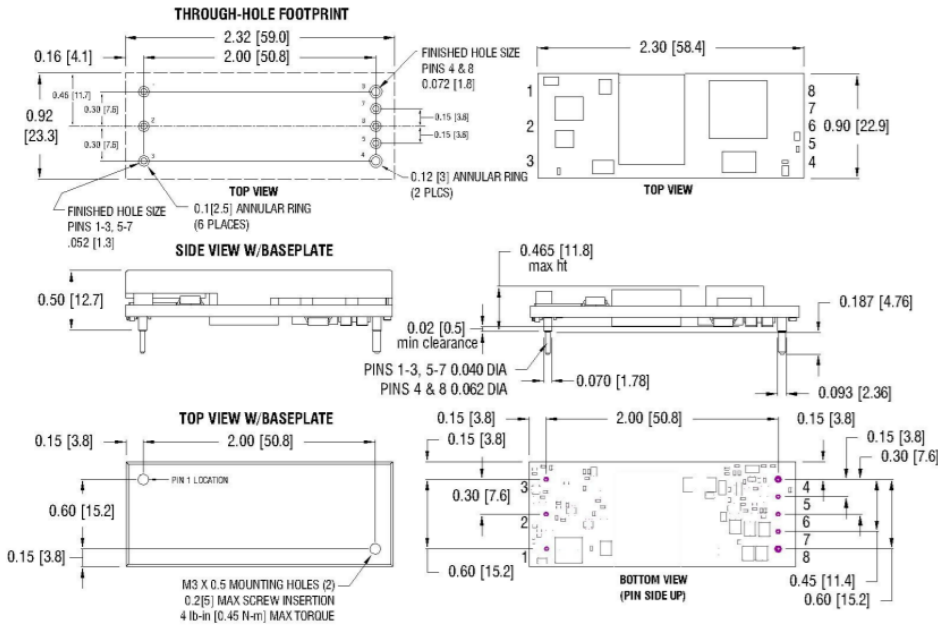


EB48S12-8 @ Vin=48 Volts



EB48S24-5 @ Vin =24 Volts

MECHANICAL SPECIFICATIONS

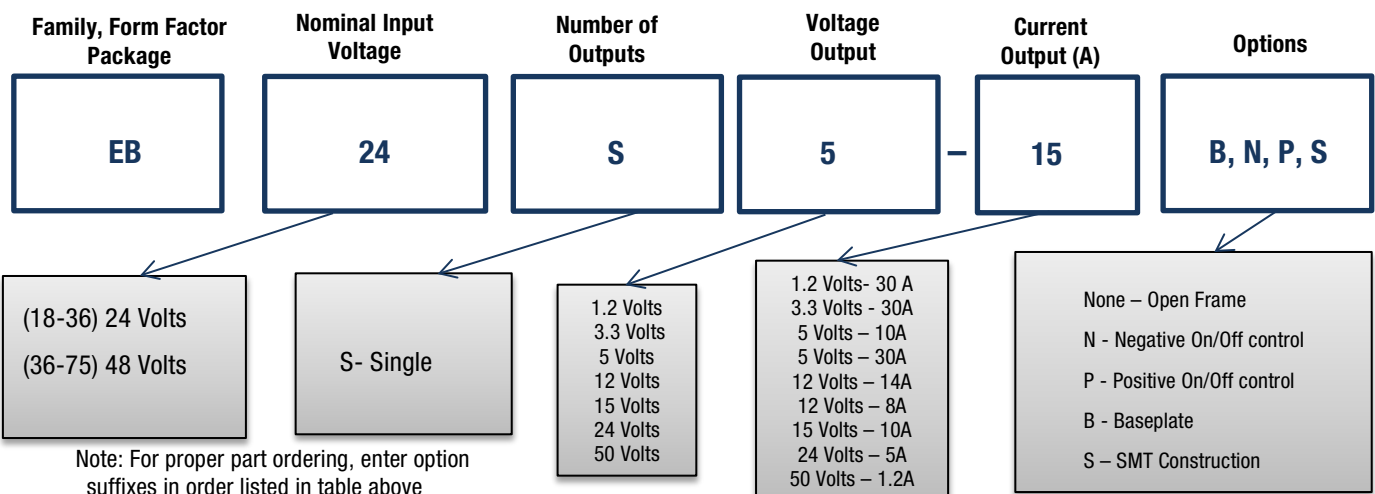


Note: All dimensions are in inches (millimeters). Tolerance: x.xx ±0.02 in. (0.5mm), x.xxx ±0.010 in. (0.25 mm) unless otherwise noted

PIN CONNECTIONS

PIN #	DESIGNATION	NOTES
1	V _{IN} (+)	1) All dimensions in inches [mm] Tolerances: .xx ± 0.02 [.x ± .5] .xxx ± 0.010 [.xx ± .25] 2) Input, on/off control and sense/trim pins are Ø 0.040" [1.02] ± 0.002" [0.05] with Ø 0.070" [1.77] standoff shoulders. 3) Output pins 4 & 8 are Ø 0.062" [1.57] ± 0.003" [0.08] with Ø 0.093" [2.36] standoff shoulders 4) All pins are gold plated with nickel under plating. 5) Weight: 12.8 g (0.45 oz.) 6) Workmanship: Meets or exceeds IPC-A-610 Class II
2	On/Off	
3	V _{IN} (-)	
4	V _{OUT} (-)	
5	Sense (-)	
6	Trim	
7	Sense (+)	
8	V _{OUT} (+)	

PART NUMBER ORDERING INFORMATION



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